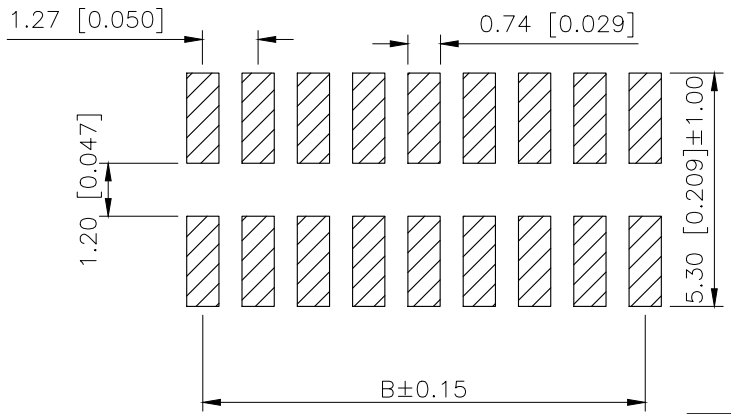
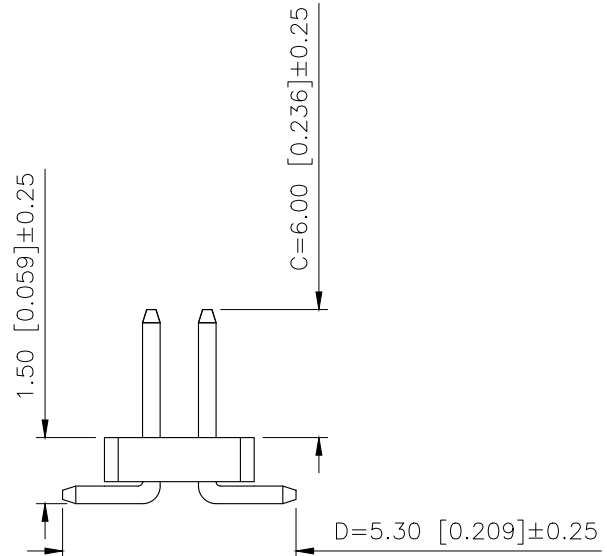
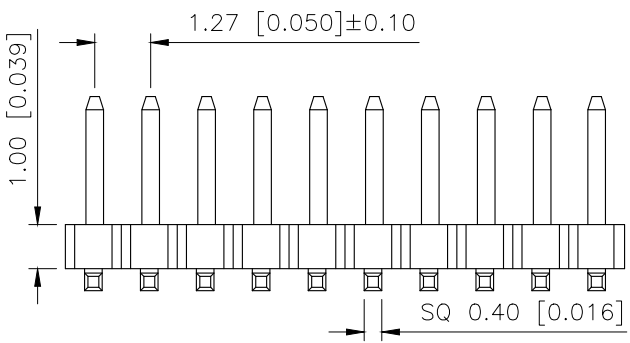
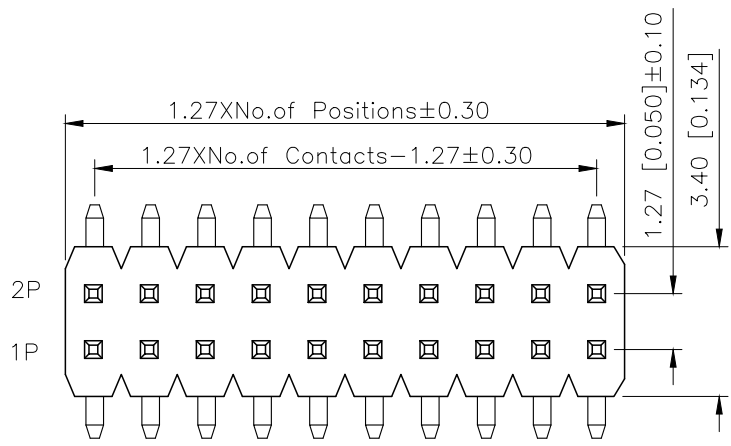


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	2025.2.24	阿树
/	N/A		/	/	/



SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c~+105°c

Contact Material:Brass
Contact Plating:Au1U
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

PART NO.:

X1321 W V S-2xXX J-C60 D53
① ② ③ ④ ⑤ ⑥ ⑦ ⑧

- ①Series No
- ②Category:W-Wafer
- ③Welding Board Angle:V-Stright 180°
- ④Welding Way:S-SMT
- ⑤Row No.Pin No:2xXX-2x02~2x40Pin
- ⑥Plastic Height:J=1.0mm
- ⑦Pin Length:C=6.0mm
- ⑧Pin Length:D=5.3mm

X1321WVS-2xXXJ-C60D53	PA6T	Brass	X1321F
PART NO	Material	Material(Pin)	Suitable XKB Female

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAUCES	



DESIGN	阿树	VIEW:	MODEL TYPE: 1.27mm BTB Connector
CHECKED		UNIT: mm/in	PART NO.: X1321WVS-2xXXJ-C60D53
APPROVED		SIZE: A4	DWG NO.: